

Data and signal line chokes

Common-mode chokes, ring core 4.7 ... 68 mH, 200 ... 700 mA, 40 °C

Series/Type: B82720H15

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Common-mode chokes, ring core

Rated voltage 42 V AC/80 V DC Rated inductance 4.7 mH to 68 mH Rated current 200 mA to 700 mA

Construction

- Current-compensated ring core double choke
- Ferrite core
- Polycarbonate case (UL 94 V-0)
- Polyurethane potting (UL 94 V-0)

Features

- Suitable for automatic insertion
- Suitable for wave soldering
- RoHS-compatible

Applications

- Telecom switching systems
- Terminal systems
- Measuring and control lines

Terminals

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Lead spacing 10 × 7.5 (mm)

Marking

Manufacturer, ordering code, rated inductance, rated current, date of manufacture (YYWWD)

Delivery mode

Cardboard box



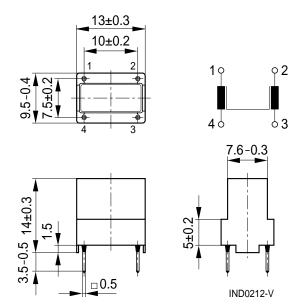


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Dimensional drawing and pin configuration



Tolerances to ISO 2768-M unless otherwise noted.

Dimensions in mm

Technical data and measuring conditions

Rated voltage V _R	42 V AC (50/60 Hz) / 80 V DC		
Rated temperature T _R	40 °C		
Rated current I _R	Referred to 50 Hz and rated temperature		
Rated inductance L _R	Measured with Agilent 4284A at 10 kHz, 0.1 mA, 20 °C Inductance is specified per winding.		
Inductance tolerance	-30%/+50% at 20 °C		
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I _R , 20 °C		
Stray inductance L _{stray,typ}	Measured with Agilent 4284A at 10 kHz, 5 mA, 20 °C, typical values		
DC resistance R _{typ}	Measured at 20 °C, typical values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 ± 5) °C, (3 ± 0.3) s Wetting of soldering area $\geq 95\%$ (to IEC 60068-2-20, test Ta)		
Resistance to soldering heat (wave soldering)	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C +40 °C, ≤75% RH		
Weight	Approx. 2.1 g		

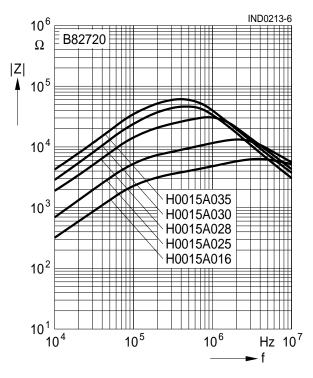
Common-mode chokes, ring core

Characteristics and ordering codes

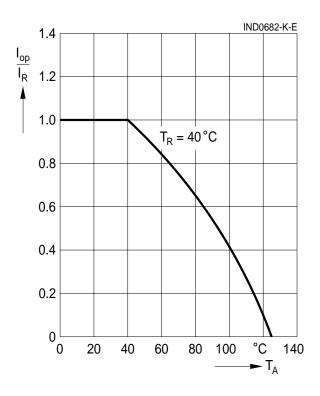
L_R	L _{stray,typ}	I _R ¹⁾	R _{typ}	V _{test}	Ordering code
mH	nH	mA	mΩ	V DC, 2 s	
4.7	300	700	500	750	B82720H0015A016
10	400	600	700	750	B82720H0015A025
28	700	400	1200	750	B82720H0015A028
47	1000	300	2700	750	B82720H0015A030
68	1200	200	3300	750	B82720H0015A035

Impedance |Z| versus frequency f

measured with windings in parallel at 20 °C, typical values



Current derating I_{op}/I_R versus ambient temperature



¹⁾ Types with higher rated current on request.



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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